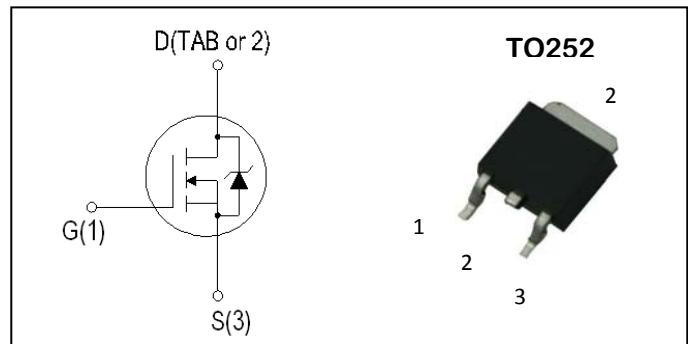


**N-Channel Enhancement Mode Field Effect Transistor****PRODUCT SUMMARY**

$V_{DSS}$	$I_D$	$R_{DS(ON)}$ ( $m\Omega$ )
60V	22A	55m $\Omega$

**Absolute Maximum Ratings (  $T_A = 25^\circ C$  unless otherwise specified )**

Symbol	Parameter	Ratings	Unit
<b>Common Ratings</b>			
$V_{DSS}$	Drain-Source Voltage	60	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	
$T_J$	Maximum Junction Temperature	150	$^\circ C$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$I_S$	Diode Continuous Forward Current	TC=25°C 22	A
<b>Mounted on Large Heat Sink</b>			
$I_{DM}$	300 $\mu$ s Pulse Drain Current Tested(1)	TC=25°C 80	A
$I_D$	Continuous Drain Current	TC=25°C 22	A
		TC=70°C 18	A
$P_D$	Maximum Power Dissipation	TC=25°C 50	W
		TC=70°C 32	W

1. Pulse width limited by maximum junction temperature.

**Thermal Characteristics**

Symbol	Parameter	Ratings	Unit
$R_{thJC}$	Thermal resistance junction-case max	2.5	$^\circ C/W$
$R_{thJA}$	Thermal resistance junction-ambient max	55	$^\circ C/W$

**Electrical Characteristics** (TA=25°C Unless Otherwise Noted)

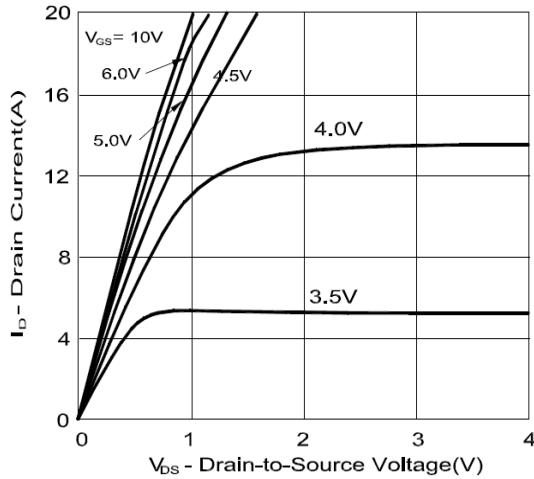
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
<b>On/off Characteristics</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>DS</sub> =250uA	60	--	--	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 48V, V <sub>GS</sub> =0V	--	--	1	uA
		V <sub>DS</sub> =40V, V <sub>GS</sub> =0V T <sub>J</sub> =55°C	--	--	10	
V <sub>G(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250uA	1	1.5	2.5	V
I <sub>GSS</sub>	Gate Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	--	--	±250	nA
R <sub>D(on)</sub>	Drain-SourceOn-stateResistance <sup>(2)</sup>	V <sub>GS</sub> = 10V, I <sub>DS</sub> =10A	--	42	55	mΩ
g <sub>FS</sub>	Forward transconductance <sup>(2)</sup>	V <sub>DS</sub> = 10V, I <sub>DS</sub> =10A	--	14	--	S
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> = 25V, Frequency=1.0MHz	--	587	--	pF
C <sub>oss</sub>	Output Capacitance		--	80	--	
C <sub>rss</sub>	Reverse Transfer Capacitance		--	46	--	
<b>Switching Characteristics</b>						
t <sub>d(ON)</sub>	Turn-on Delay Time <sup>(1)</sup>	V <sub>DD</sub> =30V, I <sub>D</sub> = 1A, V <sub>GS</sub> = 10V, R <sub>GEN</sub> =6 Ω	--	11	--	ns
t <sub>r</sub>	Turn-on Rise Time <sup>(1)</sup>		--	8	--	
t <sub>d(OFF)</sub>	Turn-off Delay Time <sup>(1)</sup>		--	19	--	
t <sub>f</sub>	Turn-off Fall Time <sup>(1)</sup>		--	6	--	
Q <sub>g</sub>	Total Gate Charge <sup>(1)</sup>	V <sub>DS</sub> =0.5V, V <sub>GS</sub> = 10V, I <sub>DS</sub> =10A	--	12.5	--	nC
Q <sub>gs</sub>	Gate-Source Charge <sup>(1)</sup>		--	1.8	--	
Q <sub>gd</sub>	Gate-Drain Charge <sup>(1)</sup>		--	3.7	--	
<b>Diode Characteristics</b>						
V <sub>SD</sub>	Diode Forward Voltage <sup>(2)</sup>	I <sub>SD</sub> = 1A, V <sub>GS</sub> = 0	--	--	1	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>SD</sub> =22A, dI <sub>SD</sub> /dt=100A/μs	--	65	--	ns
q <sub>rr</sub>	Reverse Recovery Charge		--	150	--	nC

## NOTES:

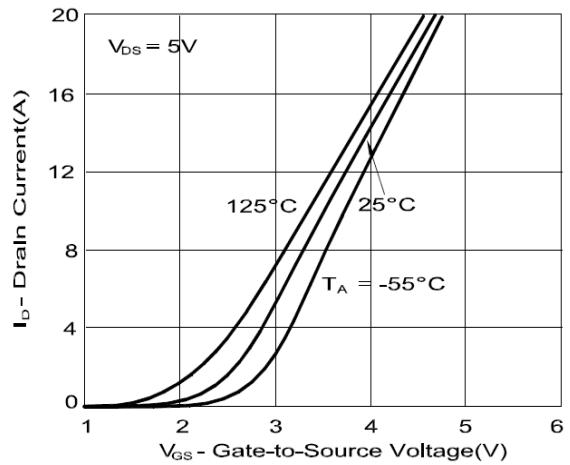
- Independent of operating temperature.
- Pulse Test : Pulse width  $\leqslant$  300 μ s, Duty cycle  $\leqslant$  2%

## Typical Performance Characteristics

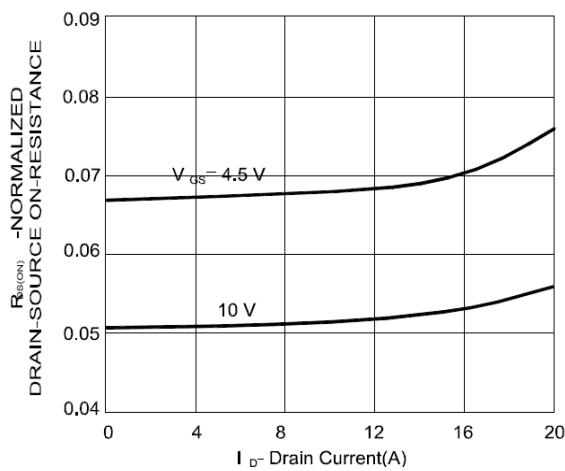
**Figure 1: On-Region Characteristics**



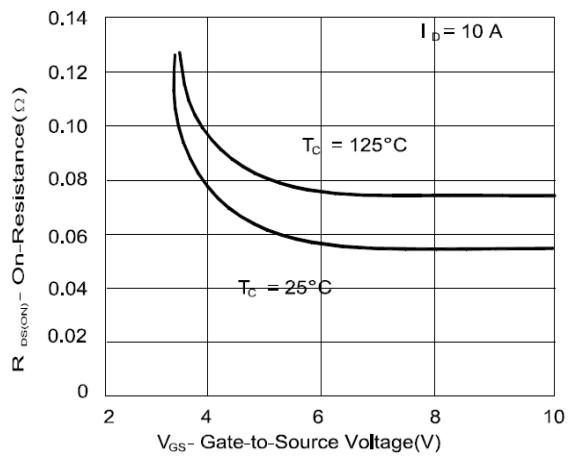
**Figure 2: Transfer Characteristics**



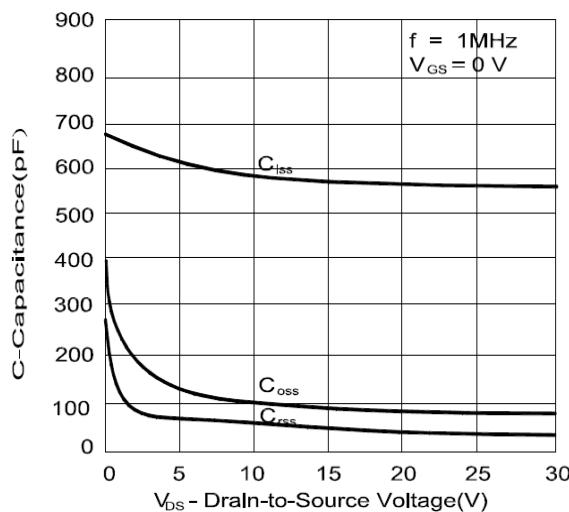
**Figure 3: Drain-Source On Resistance**



**Figure 4: On-Resistance with Gate-to-source Voltage**



**Figure 5: Capacitance Characteristics**



**Figure 6: Gate Charge Characteristics**

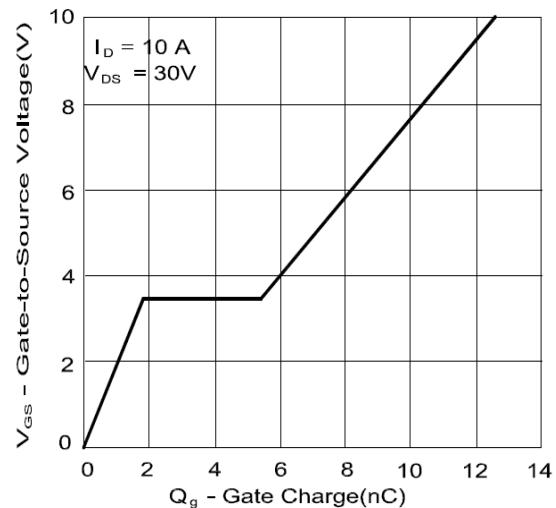


Figure 7: On-Resistance Variation vs.Temperature

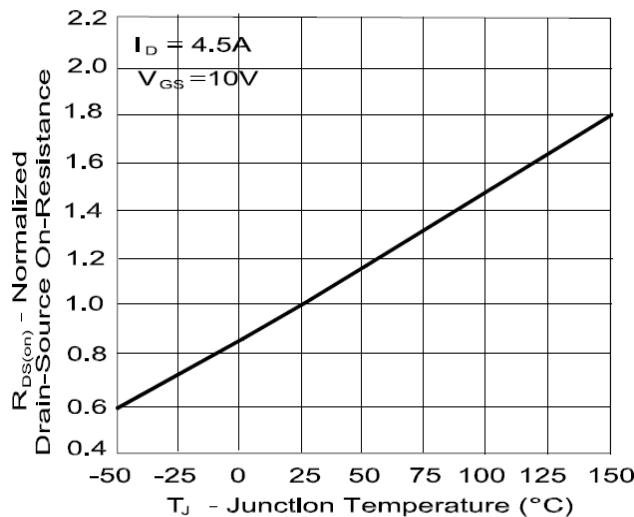


Figure 8: Body Diode Forward Voltage

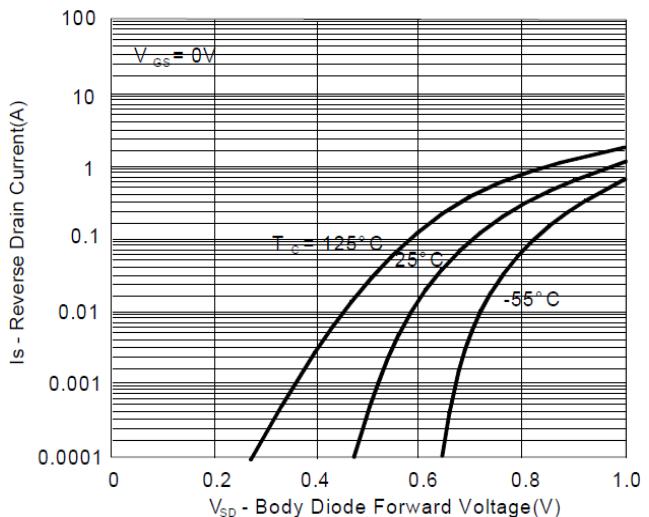


Figure 9: Maximum Safe Operating Area

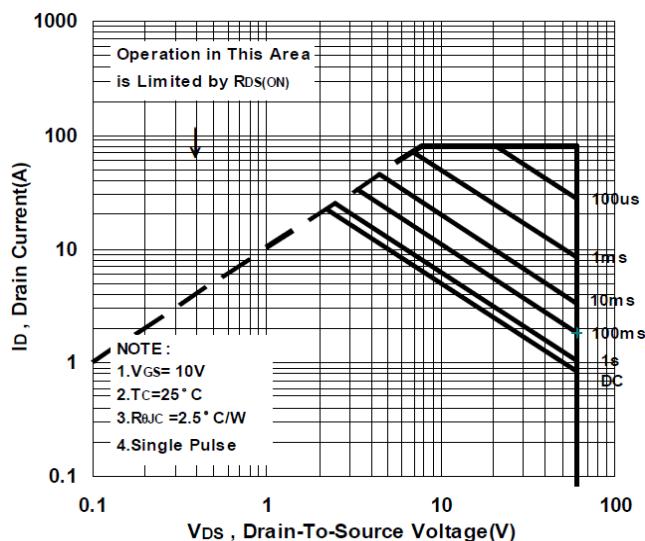


Figure 10: Pulse Maximum Power Dissipation

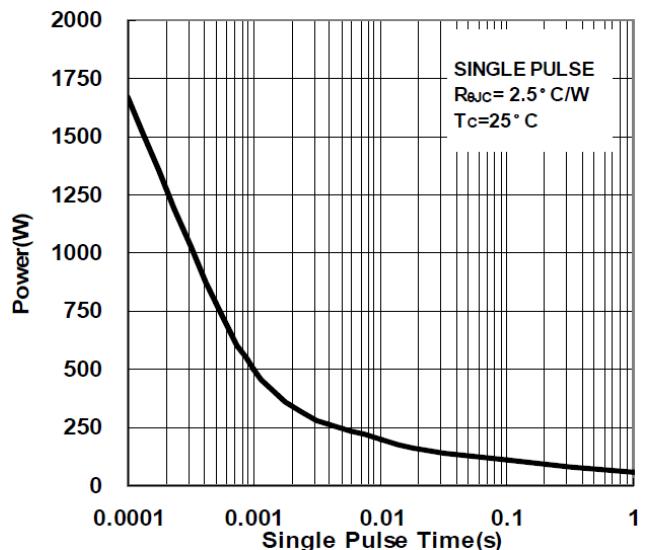
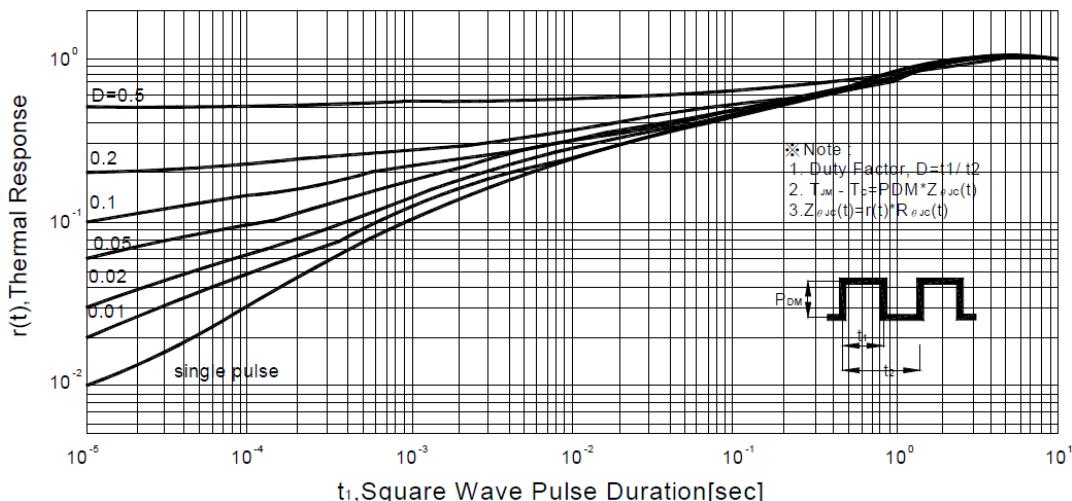
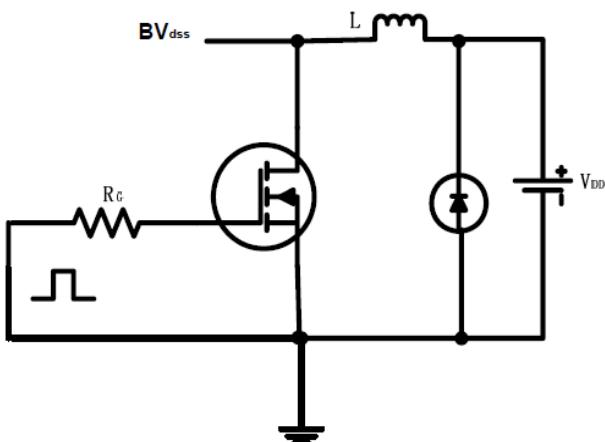


Figure 11. Transient Thermal Response Curve

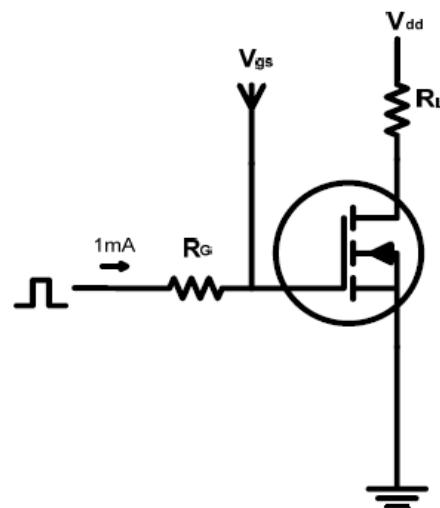


## Test circuits and Waveforms

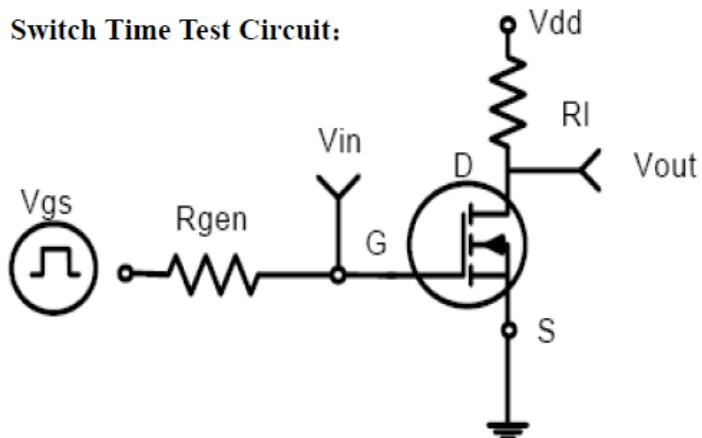
EAS test circuits:



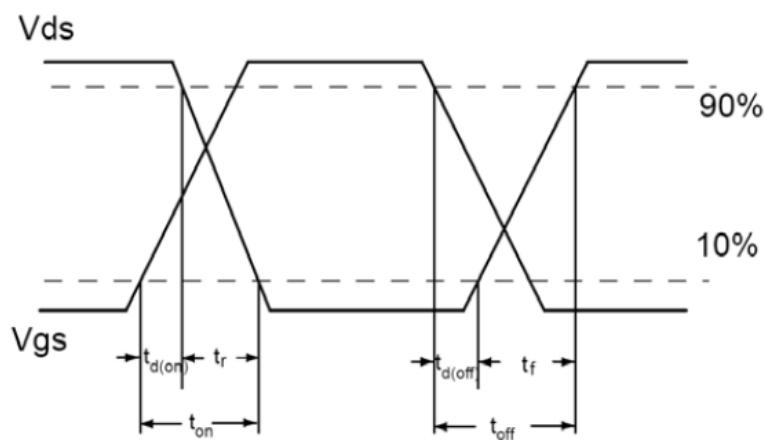
Gate charge test circuit:



Switch Time Test Circuit:

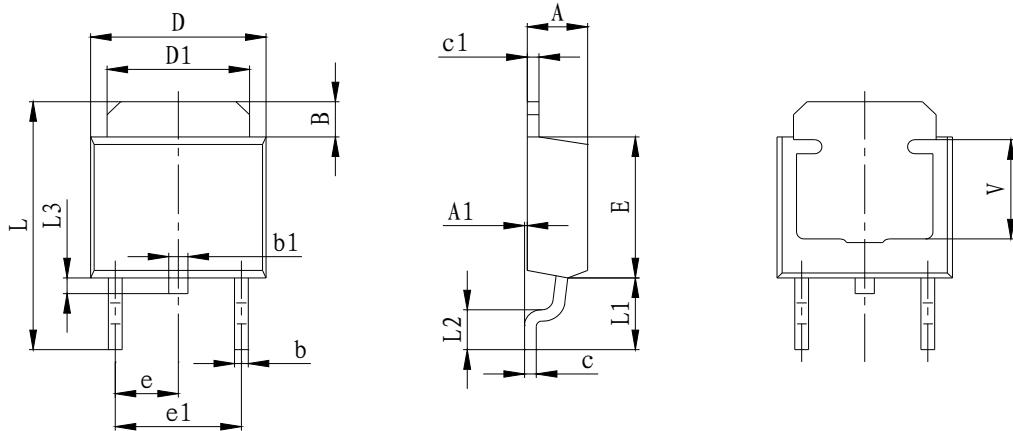


Switch Waveforms:



## PACKAGE MECHANICAL DATA

## TO-252 Package Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
B	1.350	1.650	0.053	0.065
b	0.500	0.700	0.020	0.028
b1	0.700	0.900	0.028	0.035
c	0.430	0.580	0.017	0.023
c1	0.430	0.580	0.017	0.023
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.400	5.700	0.213	0.224
e	2.300 TYP.		0.091 TYP.	
e1	4.500	4.700	0.177	0.185
L	9.500	9.900	0.374	0.390
L1	2.550	2.900	0.100	0.114
L2	1.400	1.780	0.055	0.070
L3	0.600	0.900	0.024	0.035
V	3.800 REF.		0.150 REF.	